



# Product Change Notification

**Change Notification #:** PCN 114701-01

**Change Title:** Intel® Server Chassis R2312WTXXX,  
Intel® Server System R2312WTTYSR,  
PCN 114701-01  
**Product Design**  
Removed top screws, Changed length of top cover.

**Reason for Revision: Correct the value of the Pre & Post Change TA#**

**Date of Publication:** June 24, 2016

**Date of Revision:** October 21, 2016

## Key Characteristics of the Change:

Product Design

## Forecasted Key Milestones:

<b>Date of First Availability of Post-Conversion Material:</b>	<b>October 22, 2016</b>
<b>Date Customer Must be Ready to Receive Post-Conversion Material:</b>	<b>October 22, 2016</b>

*\* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.*

## Description of Change to the Customer:

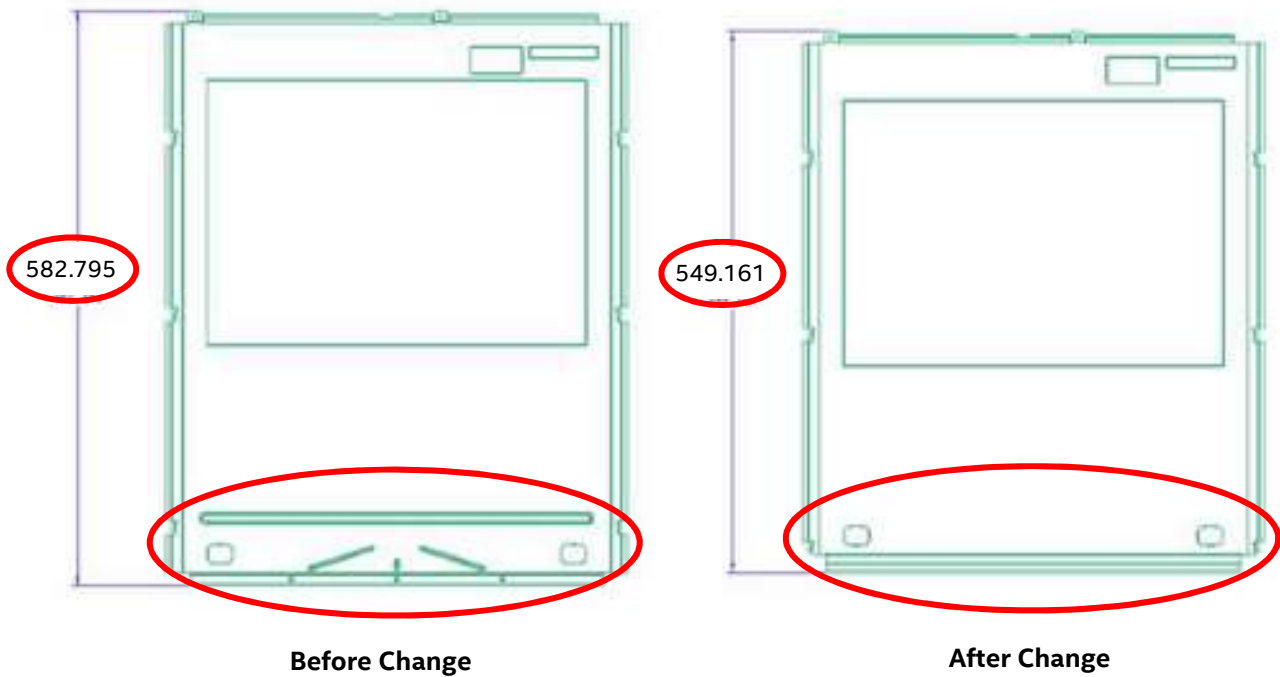
**Reason for Revision: Correct the Pre & Post Change TA# values in the Products Affected / Intel Ordering Codes table**

Please also refer to PCN 114934-00 for specific bracket change.

The date of "First Availability of Post-Conversion Material" is the projected date that a customer may expect to receive the Post-Conversion Materials. This date is determined by the projected depletion of inventory at the time of the PCN publication. The depletion of inventory may be impacted by fluctuating supply and demand, therefore, although customers should be prepared to receive the Post-Converted Materials on this date, Intel will continue to ship and customers may continue to receive the pre-converted materials until the inventory has been depleted.

Changes are applied to the Intel® Server Systems R2312WTTYSR and Intel® Server Chassis R2312WTXXX:

- Remove three screws from the top cover (Image below)
- Reduce length of the top cover (Image below)



**Customer Impact of Change and Recommended Action:**

Intel does not expect any impact to customers from these changes, but encourages customers to understand the change and determine the impact on their applications.

Please contact your local Intel Field Sales Rep if you have any further questions about these changes.

**Products Affected / Intel Ordering Codes:**

Product Code	Pre-MM#	Post-MM#	Pre Change TA	Post Change TA
R2312WTTYSR	943830	951229	<a href="#">J11495-004</a>	<a href="#">J11495-006</a>
R2312WTXXX	936022	951230	H46998-002	H46998-003

**PCN Revision History:**

Date of Revision:	Revision Number:	Reason:
June 24, 2016	00	Originally Published PCN
<a href="#">October 21, 2016</a>	<a href="#">01</a>	<a href="#">Correct the Pre/Post Change TA#</a>



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## PCN#114701-01

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**Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.**

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